

## CERTIFICATE OF COMPLIANCE

**Product covered:**

- IC in bare die,
- IC in bare die with solder or gold bumps,
- IC assembled in plastic package DIP, SOIC, QFN, PSOP, PLCC, QFP, TSSOP, SOT, SC-70, EMDFN, WLCSP, WLP, FOWLP

### REACH – EU Regulation 1907/2006 and SVHC-241 (updated on June 27<sup>th</sup>, 2024)

EM Microelectronic certifies that to the best of their knowledge and to date, the products stated above do not contain any of the REACH Substances of Very High Concern (SVHC) above the limits set by REACH Article 33, according to the Candidate list published by ECHA (European Chemical Agency).

<https://www.echa.europa.eu/candidate-list-table>

EM Microelectronic products comply with the restrictions imposed by the 76/769/EEC European Directive and which have been included in the Annex XVII of REACH.

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EM MICROELECTRONIC-MARIN SA



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